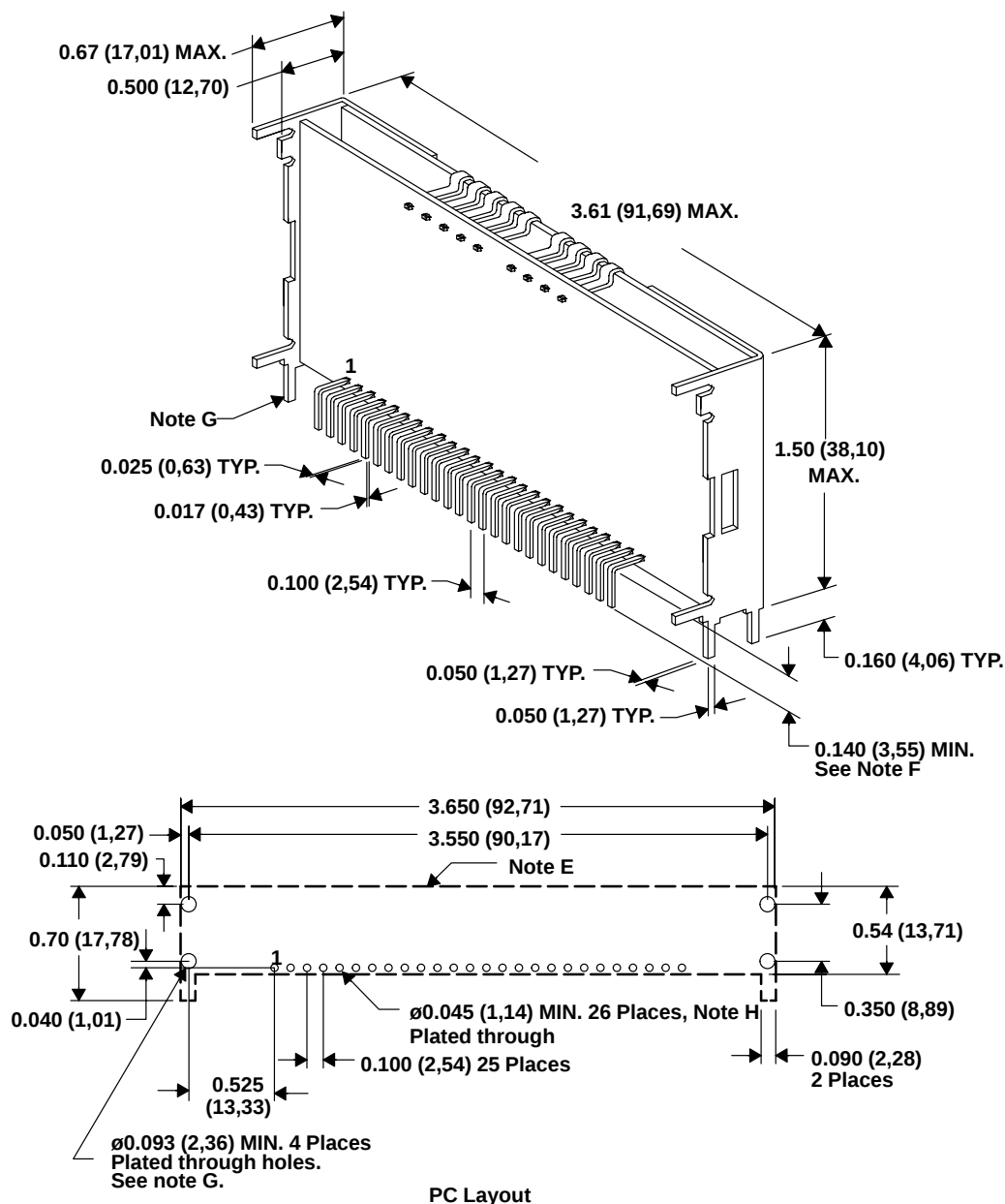


EKD (R-MSIP-T26)

METAL SINGLE-IN-LINE MODULE

Suffix N



4203503/A 08/01

- NOTES: A. All linear dimensions are in inches (mm).
 B. This drawing is subject to change without notice.
 C. 2 place decimals are ± 0.030 (± 0.76 mm).
 D. 3 place decimals are ± 0.010 (± 0.25 mm).
 E. Recommended mechanical keep out area.
 F. Electrical pin length mounted on printed circuit board, from seating plane to pin end.

- G. The case is electrically uncommitted. The recommended connection is to the secondary ground.
 H. Some pins may not be present, see product specifications.

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